



DOCKET: FIS920030192US1

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INVENTOR:	Patrick A. Coico et al.)	EXAMINER:	Michail Kornakov
)		
SERIAL NO.:	10/605,431)	ART UNIT:	1746
)		
FILING DATE:	September 30, 2003)	DATE:	October 12, 2006
)		
FOR:	NON-HERMETIC)		
	ENCAPSULANT			
	REMOVAL FOR MODULE			
	REWORK			

RESPONSE TO RESTRICTION REQUIREMENT

AND ELECTION OF SPECIES

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Responsive to the Restriction Requirement Office Action mailed September 22, 2006, and the request for election of the species made therein, applicants provisionally elect with traverse the subject matter of Group I, claims 1-14, drawn to a method for removing polymer sealant from semiconductor device.

With respect to the Species election of the Group I claims, applicants further elect with traverse the specie of metal hydroxide soluble salt of claim 11. As for claim 12, applicants elect with traverse the soluble salt specie of KOH, the solvent specie of tert-butyl alcohol, and the surfactant specie of nonionic surfactant (alcohol ethoxylate).